

Analog Master



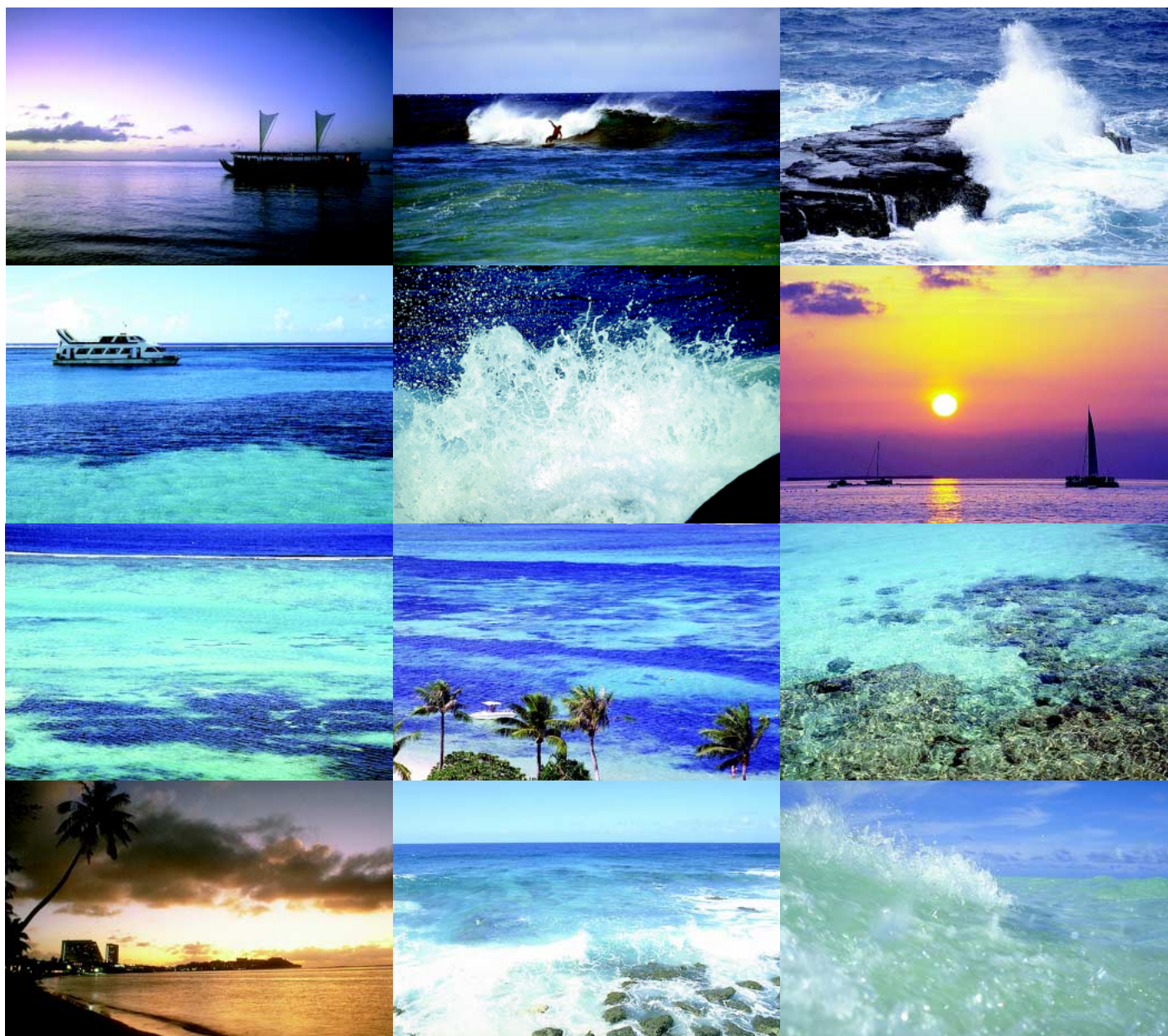
September, 2001

Wave Wave

We can find various size of waves generated in the ocean. The wave is sometimes energetic sometimes weak according to the forces of nature and the gravitational effect of the moon, an infinitely continuous activity.

We can also find another kind of wave in electric circuits: the wave of an analog signal. This wave has great significance for humankind, despite it being much smaller than the wave in the ocean.

Engineers seek to control the analog signal, this tiny and great wave, to improve the performance and accelerate downsizing of an application system.



NEC introduces Analog Master, which is a semi-custom LSI just for handling the wave of analog signals, and proposes the use the Analog Master to integrate analog circuits on one-chip, supporting powerful library of macros, variety of masters and reliable development tools.

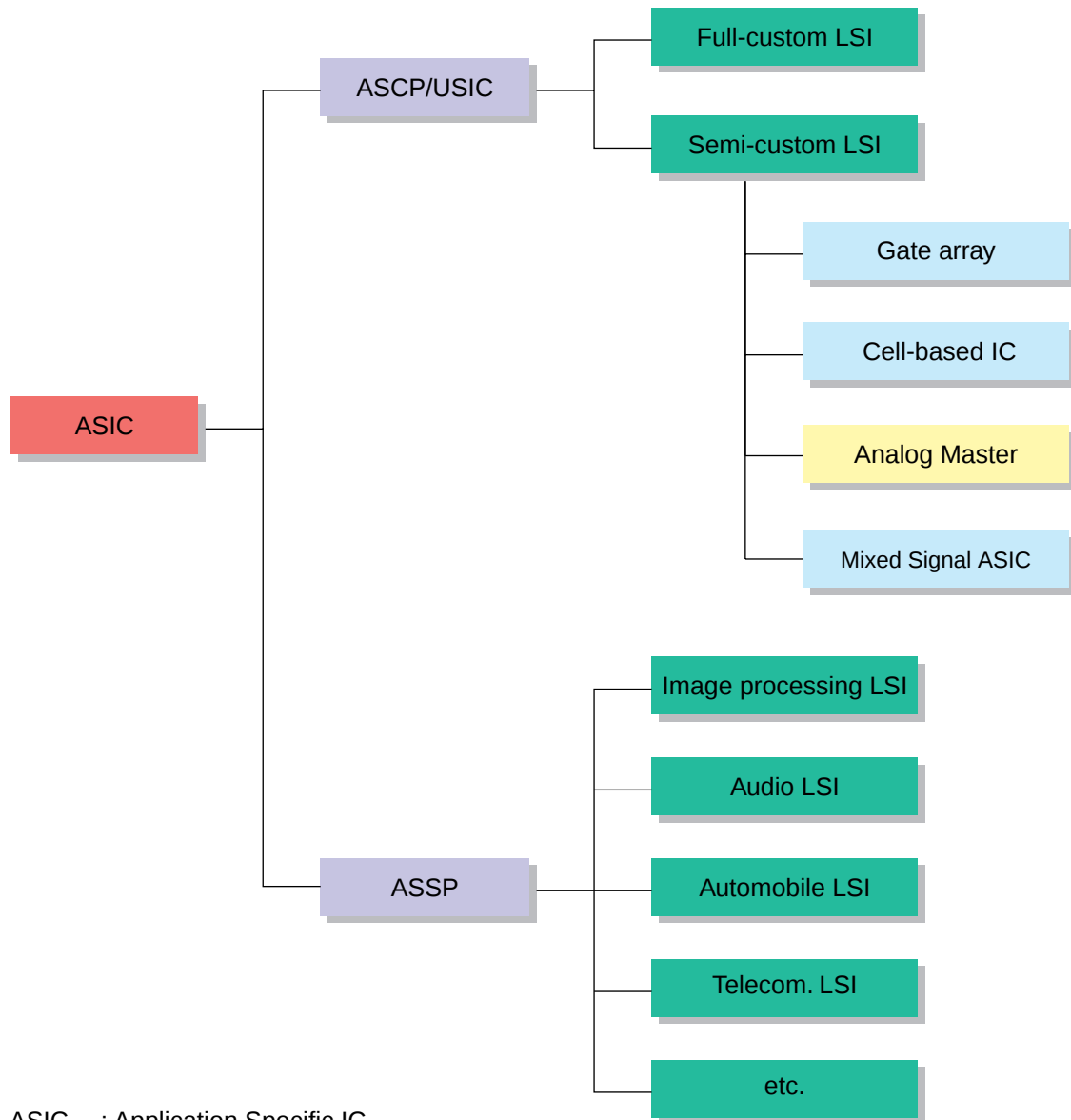


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Classification of ASICs



ASIC : Application Specific IC
ASCP : Application Specific Custom Product
USIC : User Specific IC
ASSP : Application Specific Standard Product

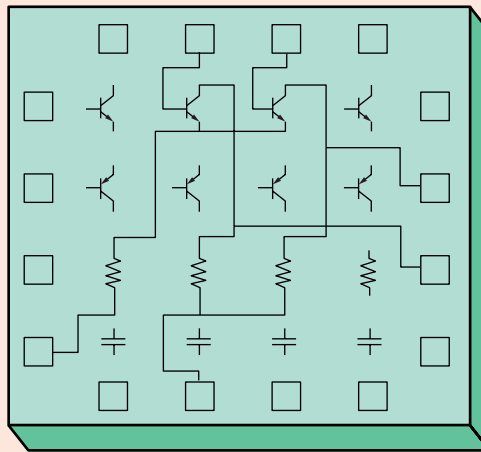
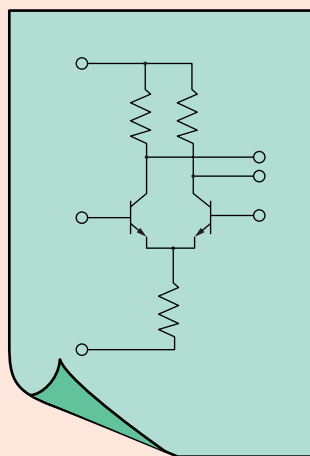
Remark For details about the Gate array and Cell-based IC, please refer to **ASIC Line-up Pamphlet(A10696E)**.

What is Analog Master?

The Analog Master is a semi-custom LSI for creating analog circuits on a master wafer by inter-connecting pre-diffused elements (bipolar transistors, resistors, and capacitors, already formed on the wafer) with the user-defined wiring.

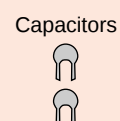
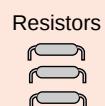
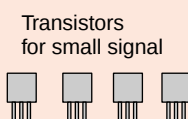
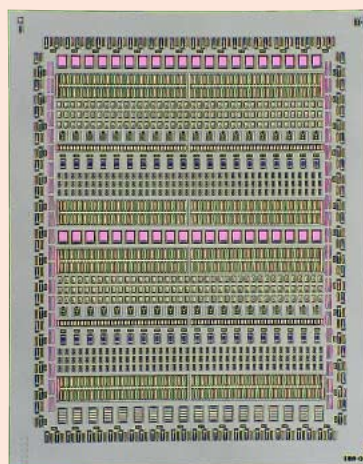
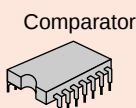
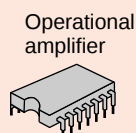
Analog Master is ideal for users who want to develop small-lot analog LSIs with low development cost in a short development period.

Realization image of an analog LSI by using Analog Master



- Bipolar process
- Transistors, resistors, and capacitors already formed on master wafer
- Elements at fixed positions

One-chip integration of analog circuits on user's application



Features of Analog Master

■ Very short development period

Four to eight weeks from layout design to ES (Engineering Sample) production

■ Powerful line-up

3 families (13 masters) are provided to cover wide range of operating frequency, voltage, and number of elements used.

General-purpose Analog Master	CHS family	: 5 masters
General-purpose Analog Master	CHS-A family	: 3 masters
High voltage Analog Master	M-CHS family	: 5 masters

■ Various macro libraries

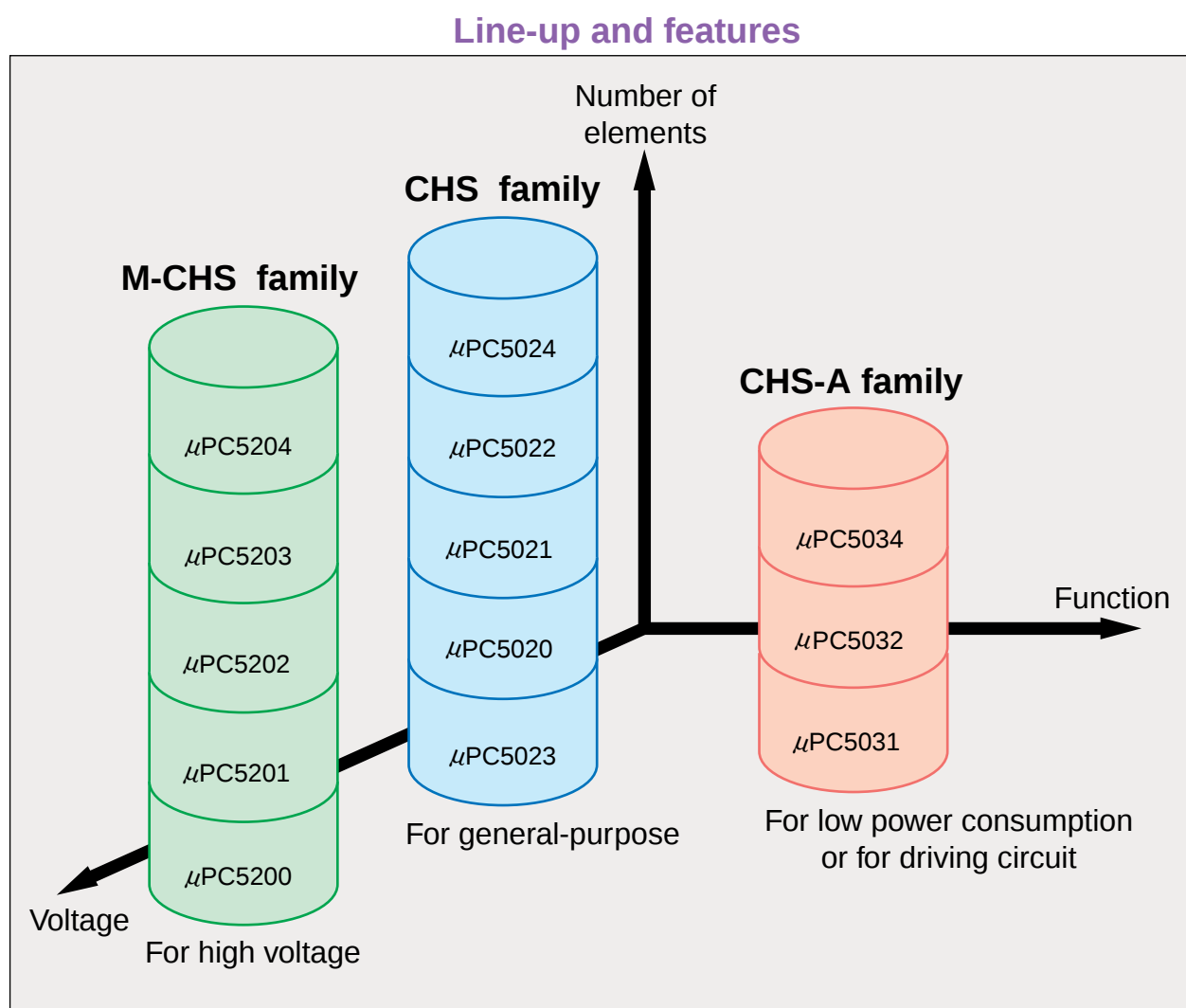
To reduce user's works, variety of macros are provided such as operational amplifier, comparator, regulator, etc.

Product Line-up of Analog Master

NEC's Analog Master is classified in the following 3 families(refer to the figure below).

- **CHS family** and **CHS-A family** for wide application field
- **M-CHS family** for high voltage

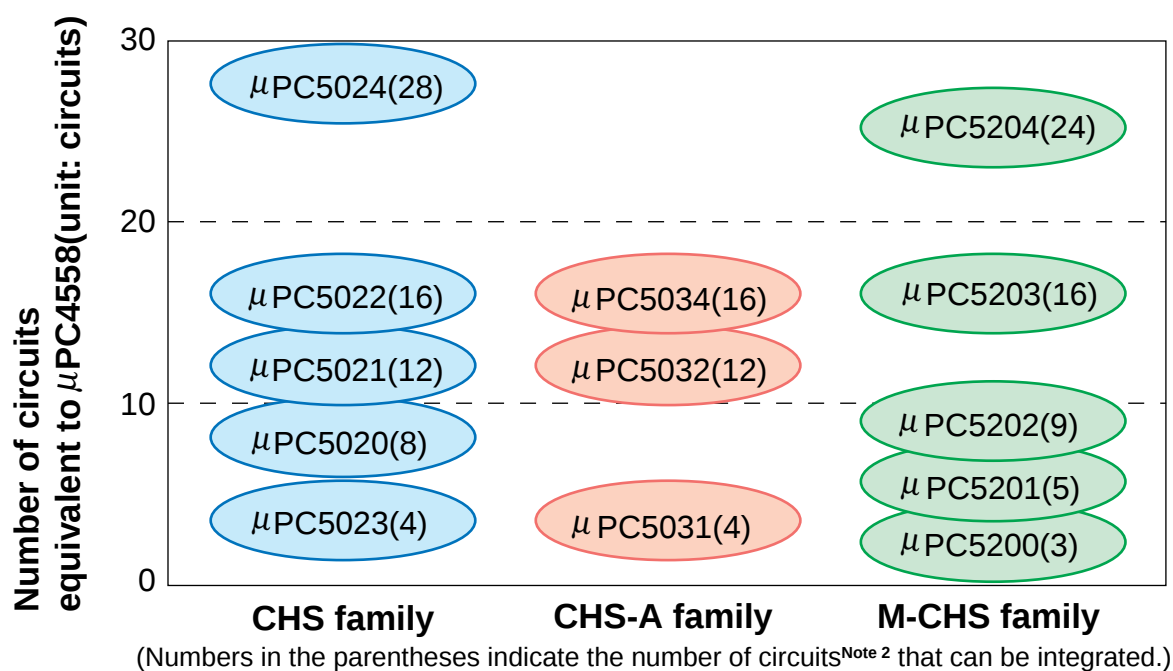
From this wide line-up (3 families 13 masters), user can achieve the optimum analog LSI.



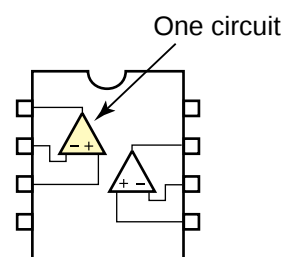
Circuit Scale of Each Family

The scale of the circuit that can be integrated on the analog master differs depending on the model of each family.

The scale of the circuit that can be integrated shown below is roughly calculated in terms of the number of circuits where one circuit is equivalent to the general-purpose operational amplifier μPC4558 ^{Note 1}.



Notes 1. One of the two operational amplifiers in the general-purpose operational amplifier μPC4558 package (8-pin DIP) is counted as one circuit.



- 2.** The number of circuits shown above is a guideline in which only operational amplifiers are integrated, and does not include operational amplifier peripheral circuits (such as feedback circuits).
When selecting a model, estimate the circuit scale by taking these peripheral circuits into consideration.

CHS Family

Features of CHS family

- High speed transistors (NPN : 6 GHz, Vertical PNP : 280 MHz)
- Excellent h_{FE} linearity of transistor
- Easy to configure low power circuits
- Adequate for circuit operating at up to 12 V and 50 MHz
- Variety of macro libraries

Element characteristics of CHS family

Element characteristics of CHS family

Element	Item	Description
Transistor	Voltage	14 V (Absolute maximum ratings)
	Transient frequency (f_T)	NPN CHT1 : 4.5 GHz CTW4 : 6.0 GHz PNP CLP1 : 7.0 MHz CVP1 : 280 MHz
	h_{FE} standard value	NPN CHT1 : 100 ($I_C = 500 \mu A$) CTW4 : 100 ($I_C = 500 \mu A$) PNP CLP1 : 200 ($I_C = 10 \mu A$) CVP1 : 75 ($I_C = 10 \mu A$)
	h_{FE} linearity (CHT1)	$h_{FE} (I_C = 10 \mu A) / h_{FE} (I_C = 100 \mu A) = 1.00$
Resistor	Resistance accuracy	Absolute accuracy : $\pm 15 \%$ (Ion-implanted) : $\pm 20 \%$ (Polysilicon) Relative accuracy (between adjacent resistors) : $\pm 2 \%$ (Ion-implanted) : $\pm 3 \%$ (Polysilicon)
Capacitor	Capacitance accuracy	Absolute accuracy : $\pm 15 \%$ Relative accuracy : $\pm 2 \%$ (between adjacent resistors)

Element configuration of CHS family

- 5 masters are available from μ PC5023 to μ PC5024 for small to large complexity circuit, respectively.
- The CHS family should be designed so that the utilization rate of each element is up to 70 % (Only μ PC5023 should be designed up to 60 %).

Masters of CHS family

Part Number		μ PC5020	μ PC5021	μ PC5022	μ PC5023	μ PC5024	Remarks
Technology		High-speed bipolar technology					Name : CHS
Supply voltage		14 V					Abusolute maximum ratings
Number of pads		28	32	50	22	80	
Total number of elements		1627	2327	3041	726	6151	
Total number of transistors		484	688	892	245	1508	
NPN transistors	CHT1	224	320	416	112	672	$I_{C(MAX.)} = 2 \text{ mA}^{\text{Note1}}$
	CTW4	28	40	52	13	84	$I_{C(MAX.)} = 18 \text{ mA}^{\text{Note2}}$
	CEW4	8	8	8	4	80	$I_{C(MAX.)} = 18 \text{ mA}^{\text{Note2}}$ (For electro-static protection)
PNP transistors	CLP1	168	240	312	84	504	$I_{C(MAX.)} = 0.05 \text{ mA}^{\text{Note1}}$ (Lateral type)
	CVP1	56	80	104	32	168	$I_{C(MAX.)} = 0.5 \text{ mA}^{\text{Note1}}$ (Vertical type)
Total number of resistors		1116	1600	2098	468	4560	
Ion-implanted resistors	500 Ω	544	784	1024	224	1664	P ⁺ resistor
	5 k Ω	544	784	1024	200	2496	P ⁻ resistor
Polysilicon resistors	2.5 k Ω	28	32	50	—	—	N ⁺ resistor
	3 k Ω	—	—	—	44	400	N ⁺ resistor
Number of capacitors(5 pF)		27	39	51	13	83	MOS capacitor

Notes 1. $I_{C(MAX.)}$ is a collector current value that reduces the value of DC current amplification factor h_{FE} by 30 % compared to its peak value.
2. Maximum collector current value whose reliability can be guaranteed because it is limited by the maximum current density.

Macro library

- TEGs are also provided.

Macro library of CHS family

Function	Library Name	Feature	Specifications	Equivalent	Availability
Operational amplifier	OA01A	General-purpose	$V_{IO} : 1.4 \text{ mV (TYP.)}$	μPC4558	Available
	OA02A	Single power supply, high-speed	$SR^+ : 8 \text{ V}/\mu\text{s (TYP.)}$	μPC842	Available
	OA03A	Low power	$I_{CC} : 5 \mu\text{A (TYP.)}, I_{SET} = 1 \mu\text{A}$	μPC4250	Available
	OA04B	High input impedance	$I_b : 1 \text{ nA (TYP.)}$	—	Available
	OA06B	Single power supply, stable	$V_{ICM} : 0 \text{ to } V^+ - 1.5\text{V}$	μPC358	Available
	OA06C	Single power supply, V_{om}^+ improved	$V_{om}^+ : V^+ - 1.2 \text{ V (MIN.)}$	μPC358	Available
	OA07A	High-speed, high stability	$SR^+ : 70 \text{ V}/\mu\text{s (TYP.)}$	—	Available
	OA07B	High-speed, wide band	$GBW : 200 \text{ MHz (TYP.)}$	—	Available
	OA08	Low noise	$e_n : 6.5 \text{ nV}/\sqrt{\text{Hz}} \text{ (TYP.)}$	—	Available
	OA09	General-purpose (reduced element version)	$V_{IO} : 1.2 \text{ mV (TYP.)}$	—	Available
	OA10	NPN input low noise	$e_n : 3 \text{ nV}/\sqrt{\text{Hz}} \text{ (TYP.)}$	—	Available
Comparator	CP02A	High-speed	$t_{PD} : 80 \text{ ns (TYP.)}$	μPC319	Available
	CP04	Single power supply	$t_{PD} : 0.5 \mu\text{s (TYP.)}$	μPC393	Available
Regulator	RG01A	General-purpose	$V_O : 1.3 \text{ to } 9.0 \text{ V}$	—	Available
	RG02A	General-purpose	$V_O : 2.7 \text{ to } 9.5 \text{ V}$	—	Available
	RG03	Low saturation		—	Available
Switch	SW01A	Bi-directional switch (High-active)		—	Available
	SW01B	Bi-directional switch (Low-active)		—	Available
	SW02	Signal switch		—	Available
Timer	TM01	Timer		μPC1555	Available

Remark TEG (Test Element Group) is a sample of macro.

CHS-A Family

Features of CHS-A family

- Compatible with the CHS family (same process as CHS family is employed)
- Many-pin masters solving shortage of number of pins
- Total internal resistance 2 times higher than the CHS family
- Internal transistor for output driver (drive up to 50 mA)
- Super white TEG supporting application to microcontroller's peripheral analog circuits

Element characteristics of CHS-A family

Element characteristics of CHS-A family

Element	Item	Description
Transistor	Voltage	14 V (Absolute maximum ratings)
	Transient frequency (f_T)	NPN CST1 : 4.5 GHz CTW3 : 5.0 GHz PNP CLP1 : 7.0 MHz CVP1 : 280 MHz
	h_{FE} standard value	NPN CST1 : 100 ($I_C = 500 \mu A$) CTW3 : 100 ($I_C = 500 \mu A$) PNP CLP1 : 200 ($I_C = 10 \mu A$) CVP1 : 75 ($I_C = 10 \mu A$)
	h_{FE} linearity (CST1)	$h_{FE} (I_C = 10 \mu A) / h_{FE} (I_C = 100 \mu A) = 1.00$
Resistor	Resistance accuracy	Absolute accuracy : $\pm 15 \%$ (Ion-implanted) $\pm 20 \%$ (Polysilicon) Relative accuracy (between adjacent resistors) : $\pm 2 \%$ (Ion-implanted) $\pm 3 \%$ (Polysilicon)
Capacitor	Capacitance accuracy	Absolute accuracy : $\pm 15 \%$ Relative accuracy : $\pm 2 \%$ (between adjacent resistors)

Element configuration of CHS-A family

- Three masters with a different circuit scale and number of output driver transistors are available.
- The CHS-A family should be designed so that the utilization rate of each element is up to 70 %.

Masters of CHS-A family

Part Number		μ PC5031	μ PC5032	μ PC5034	Remarks
Technology		High-speed bipolar technology			Name : CHS
Supply voltage		14 V			Absolute maximum ratings
Number of pads		36	56	82	
Total number of elements		575	1471	2251	
Total number of transistors		223	578	896	
NPN transistors	CST1	90	240	360	$I_{C(MAX.)} = 2 \text{ mA}$ ^{Note1}
	CTW3	15	40	60	$I_{C(MAX.)} = 18 \text{ mA}$ ^{Note2}
	CEW4	13 ^{Note3}	18 ^{Note3}	26 ^{Note3}	$I_{C(MAX.)} = 25 \text{ mA}$ ^{Note2} (For electro-static protection)
PNP transistors	CLP1	90	240	360	$I_{C(MAX.)} = 0.05 \text{ mA}$ ^{Note1} (Lateral type)
	CVP1	15	40	90	$I_{C(MAX.)} = 0.5 \text{ mA}$ ^{Note1} (Vertical type)
Total number of resistors		338	854	1266	
Ion-implanted resistors	2 k Ω	58	154	234	P ⁻ resistor
	10 k Ω	232	616	936	P ⁻ resistor
Polysilicon resistors	3 k Ω	48	84	96	N ⁺ resistor
Number of capacitors(5 pF)		14	39	89	MOS capacitor

- Notes**
1. $I_{C(MAX.)}$ is a collector current value that reduces the value of DC current amplification factor h_{FE} by 30 % compared to its peak value.
 2. Maximum collector current value whose reliability can be guaranteed because it is limited by the maximum current density.
 3. When used as 50-mA output drivers, the number of elements is halved.

CHS-A Family

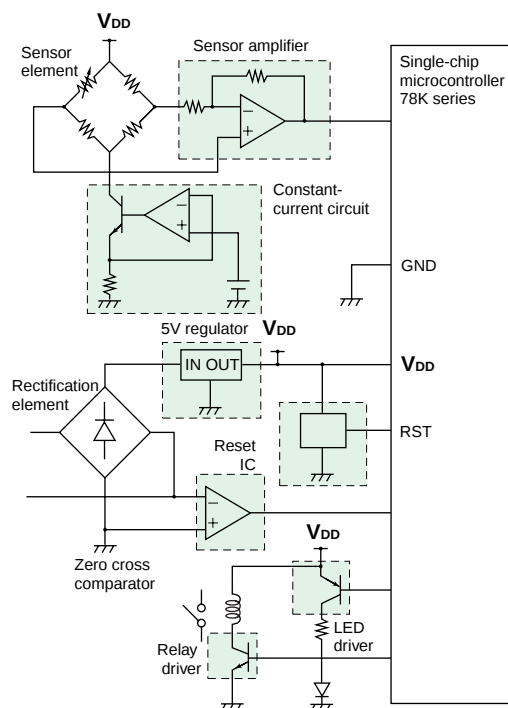
Macro library

- TEGs are also provided.

Macro library of CHS-A family

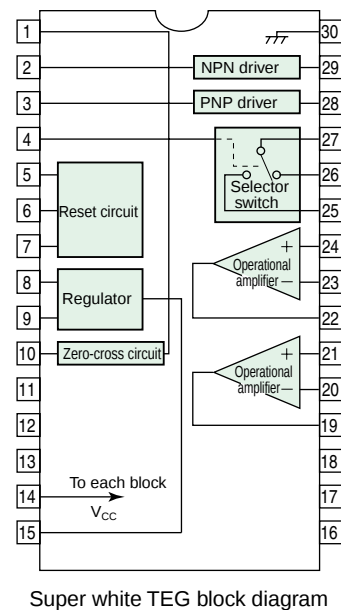
Function	Library Name	Feature	Specifications	Equivalent	Availability
Operational amplifier	OA0301	General-purpose	$V_{IO} : 1.4 \text{ mV (TYP.)}$	μPC4558	Available
	OA0302	Single power supply, high-speed	$SR^+ : 5 \text{ V}/\mu\text{s (TYP.)}$	μPC842	Available
	OA0303	Low power	$I_{CC} : 6 \mu\text{A (TYP.)}, I_{SET} = 1 \mu\text{A}$	μPC4250	Available
	OA0304	High input impedance	$I_B : 1 \text{ nA (TYP.)}$	—	Available
	OA0306B	Single power supply, general-purpose	$V_{ICM} : 0 \text{ to } V^+ - 1.4 \text{ V (TYP.)}$	μPC358	Available
	OA0309	General-purpose (reduced element version)		—	Available
Comparator	CP0304	Single power supply	$t_{PD} : 0.5 \mu\text{s (TYP.)}$	μPC393	Available
Regulator	RG0301	General-purpose	$V_O : 1.3 \text{ to } V_{CC} - 2 \text{ V}$	—	Available
Switch	SW0302	Signal switch		—	Available
Super white TEG ^{Note}	WT03A	Operational amplifier x 2, regulator, signal switch, driver x 2		—	Available

Note Provided with an analog circuit for use microcontroller peripherals. (package : 30-pin shrink DIP)



Example of using super white TEG

Use the Super White TEG at the locations enclosed by the dotted lines in figure.



Super white TEG block diagram

M-CHS Family

Features of M-CHS family

- Maximum supply voltage : 44 V
- High speed transistors (NPN : 2 GHz, vertical PNP : 50 MHz)
- Incorporates low noise lateral PNP transistors (HLP2A transistor)
- Adequate for circuit operating at up to 40 V and 10 MHz

Element characteristics of M-CHS family

Element characteristics of M-CHS family

Element	Item	Description
Transistor	Voltage	44 V (Absolute maximum ratings)
	Transient frequency (fr)	NPN HDT1 : 2 GHz HTW4 : 2 GHz PNP HLP2 : 2 MHz HVP3 : 50 MHz
	h _{FE} standard value	NPN HDT1 : 100 (I _C = 500 μA) HTW4 : 100 (I _C = 500 μA) PNP HLP2 : 100 (I _C = 10 μA) HVP3 : 100 (I _C = 10 μA)
	h _{FE} linearity (HDT1)	h _{FE} (I _C = 10 μA)/h _{FE} (I _C = 100 μA) = 1.00
Resistor	Resistance accuracy	Absolute accuracy : ±15 % (Ion-implanted) ±20 % (Polysilicon) Relative accuracy (between adjacent resistors) : ±2 % (Ion-implanted) : ±3 % (Polysilicon)
Capacitor	Capacitance accuracy	Absolute accuracy : ±15 % Relative accuracy : ±2 % (between adjacent capacitors)

M-CHS Family

Element configuration of M-CHS family

- 5 masters are available from μPC5200 to μPC5204 for small to large complexity circuit, respectively.
- The M-CHS family should be designed so that the utilization rate of each element is up to 70 %.

Masters of M-CHS family

Part Number		μPC5200	μPC5201	μPC5202	μPC5203	μPC5204	Remarks
Technology		High-speed, high voltage bipolar technology					Name : M-CHS
Supply voltage		44 V					Absolute maximum ratings
Number of pads		24	28	40	52	62	
Total number of elements		653	1029	1786	3087	4561	
Total number of transistors		189	303	535	932	1382	
NPN transistors	HDT1	72	120	216	384	576	$I_{C(\text{MAX.})} = 1.0 \text{ mA}$ ^{Note1}
	HTW4	9	15	27	48	72	$I_{C(\text{MAX.})} = 10 \text{ mA}$ ^{Note1}
	HEW4	12	14	20	26	31	$I_{C(\text{MAX.})} = 10 \text{ mA}$ ^{Note1}
	HTT5	12	14	20	26	31	$I_{C(\text{MAX.})} = 18 \text{ mA}$ ^{Note2}
PNP transistors	HLP2	48	80	144	256	384	$I_{C(\text{MAX.})} = 0.12 \text{ mA}$ ^{Note1} (Lateral type)
	HLP2A	18	30	54	96	144	Low noise PNP $I_{C(\text{MAX.})} = 0.12 \text{ mA}$ ^{Note1} (Lateral type)
	HVP3	18	30	54	96	144	$I_{C(\text{MAX.})} = 1.0 \text{ mA}$ ^{Note1} (Vertical type)
Total number of resistors		456	712	1225	2108	3108	
Ion-implanted resistors	500 Ω	144	240	426	760	1144	P^+ resistor
	10 k Ω	216	360	639	1140	1716	P^- resistor
Polysilicon resistors	500 Ω	96	112	160	208	248	N^+ resistor
Number of capacitors(5 pF)		8	14	26	47	71	MOS capacitor

Notes 1. $I_{C(\text{MAX.})}$ is a collector current value that reduces the value of DC current amplification factor h_{FE} by 30 % compared to its peak value.

2. Maximum collector current value whose reliability can be guaranteed because it is limited by the maximum current density.

Macro library

- TEGs are also provided.

Macro library of M-CHS family

Function	LibraryName	Feature	Specifications	Equivalent	Availability
Operational amplifier	OA201	General-purpose	$V_{IO} : 1.0 \text{ mV (TYP.)}$	μPC4558	Available
	OA202	Single power supply, stable	$V_{ICM} : 0 \text{ to } V^+ - 1.5 \text{ V}$	μPC358	Available
	OA203	Low power	$I_{CC} : 16 \mu\text{A (TYP.)}$, $I_{SET} = 2 \mu\text{A}$	μPC4250	Available
	OA204	High input impedance	$I_B : 1.2 \text{ nA (TYP.)}$	—	Available
	OA205A	High-speed, high stability	$SR^+ : 30 \text{ V}/\mu\text{s (TYP.)}$	—	Available
	OA205B	High-speed, wide band	$f_{unity} : 50 \text{ MHz (TYP.)}$	—	Available
	OA205C	High-speed, 1 block version		—	Available
	OA206	Low noise	$e_n : 4.5 \text{ nV}/\sqrt{\text{Hz}} \text{ (TYP.)}$	μPC4570	Available
	OA207	Single power supply, high-speed	$SR^+ : 7.5 \text{ V}/\mu\text{s (TYP.)}$	μPC842	Available
Comparator	CP201	Single power supply	$t_{PD} : 3 \mu\text{s (TYP.)}$	—	Available
	CP202	High-speed	$t_{PD} : 180 \text{ ns (TYP.)}$	μPC319	Available
Regulator	RG201	General-purpose		—	Available
Switch	SW201A	Bi-directional switch (High-active)		—	Available
	SW201B	Bi-directional switch (Low-active)		—	Available
	SW202	Signal switch		—	Available

Remark TEG (Test Element Group) is a sample of macro.

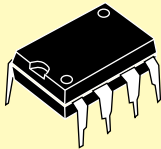
Packages

To meet various requirements about the package type and the number of pins, variety of packages are available for the Analog Master. User can select optimum combination for each application. For availability, refer to the tables of the following pages.

Packages available for Analog Master

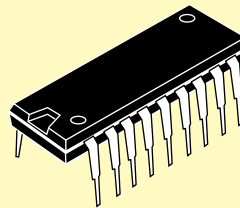
DIP

14-pin (7.62 mm(300))
16-pin (7.62 mm(300))
18-pin (7.62 mm(300))
22-pin (10.16 mm(400))



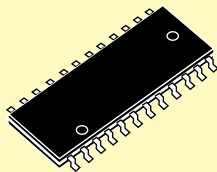
Shrink DIP

18-pin (7.62 mm(300))
20-pin (7.62 mm(300))
22-pin (7.62 mm(300))
24-pin (7.62 mm(300))
28-pin (10.16 mm(400))
30-pin (10.16 mm(400))
42-pin (15.24 mm(600))
48-pin (15.24 mm(600))



SOP

8-pin (5.72mm (225))
14-pin (5.72mm (225))
16-pin (5.72mm (225))
16-pin (7.62mm (300))
16-pin (9.53mm (375))
20-pin (7.62mm (300))
24-pin (7.62mm (300))
24-pin (9.53mm (375))
28-pin (9.53mm (375))

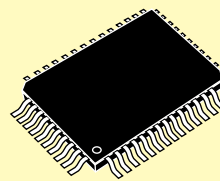


Shrink SOP

14-pin (5.72mm (225))
16-pin (5.72mm (225))
20-pin (5.72mm (225))
20-pin (7.62mm (300))
24-pin (7.62mm (300))
30-pin (7.62mm (300))
36-pin (7.62mm (300))
38-pin (7.62mm (300))

QFP

48-pin (7 × 7)
48-pin (10 × 10)
48-pin (10 × 14)
56-pin (10 × 10)
64-pin (14 × 20)
68-pin (10 × 14)
72-pin (10 × 10)
80-pin (14 × 14)
80-pin (14 × 20)



TQFP

48-pin (7 × 7)

Package availability of CHS family

Package		Lead Pitch	μPC5020	μPC5021	μPC5022	μPC5023	μPC5024
DIP	8-pin	2.54 mm	—	—	—	—	—
	14-pin	2.54 mm	—	—	—	○	—
	16-pin	2.54 mm	—	—	—	○	—
	18-pin ^{Note}	2.54 mm	—	—	—	○	—
	22-pin	2.54 mm	—	—	○	—	—
Shrink DIP	14-pin	1.778 mm	—	—	—	—	—
	18-pin	1.778 mm	—	○	—	○	—
	20-pin	1.778 mm	—	—	—	○	—
	22-pin	1.778 mm	—	—	—	○	—
	24-pin	1.778 mm	○	○	—	—	—
	28-pin	1.778 mm	—	—	○	—	—
	30-pin	1.778 mm	—	○	○	—	—
	42-pin ^{Note}	1.778 mm	—	—	○	—	—
	48-pin	1.778 mm	—	—	—	—	—
SOP	8-pin	1.27 mm	—	—	—	○ (5.72 mm)	—
	14-pin	1.27 mm	—	—	—	○ (5.72 mm)	—
	16-pin	1.27 mm	○ (7.62 mm)	○ (9.53 mm)	—	○ (5.72 mm)	—
	20-pin	1.27 mm	○ (7.62 mm)	○ (7.62 mm)	—	○ (7.62 mm)	—
	24-pin	1.27 mm	○ (7.62 mm)	○ (7.62 mm)	○ (9.53 mm)	○ (7.62 mm)	—
	28-pin	1.27 mm	○ (9.53 mm)	○ (9.53 mm)	○ (9.53 mm)	—	—
Shrink SOP	14-pin	0.65 mm	—	—	—	○ (5.72 mm)	—
	16-pin	0.65 mm	—	—	—	○ (5.72 mm)	—
	20-pin	0.65 mm	○ (5.72 mm)	—	—	○ (5.72 mm)	—
		0.65 mm	○ (7.62 mm)	—	—	—	—
	24-pin	0.65 mm	○ (7.62 mm)	—	—	○ (7.62 mm)	—
	30-pin	0.65 mm	—	○ (7.62 mm)	—	—	—
	36-pin	0.8 mm	○ (7.62 mm)	—	—	—	—
QFP	48-pin	0.5 mm	—	○ (7 x 7)	○ (7 x 7)	—	—
		0.65 mm	—	—	○ (10 x 10)	—	—
		0.8 mm	—	—	○ (10 x 14)	—	○ (10 x 14)
	64-pin	1.0 mm	—	—	—	—	○ (14 x 20)
	68-pin	0.65 mm	—	—	—	—	○ (10 x 14)
	80-pin	0.8 mm	—	—	—	—	○ (14 x 20)
TQFP	48-pin	0.5 mm	—	○ (7 x 7)	○ (7 x 7)	—	—

Note Because the time is required to prepare for production, consult NEC before development. Also consult NEC when you use 42-pin shrink DIP packages.

Remarks1. In the above table, '○' indicates a package that is available, and '—' indicates a package that is unavailable.
2. Some packages may have unavailable pins. Please refer to the **Analog Master Package Manual (A10495E)** for unavailable pins.

Packages

Package availability of CHS-A family

Package		Lead Pitch	μPC5031	μPC5032	μPC5034
Shrink DIP	18-pin	1.778 mm	—	—	—
	22-pin	1.778 mm	○(7.62 mm)	—	—
	24-pin	1.778 mm	—	—	—
	28-pin	1.778 mm	—	—	—
	30-pin	1.778 mm	—	○(10.16mm)	—
SOP	16-pin	1.27 mm	○(7.62 mm)	○(7.62 mm)	—
	20-pin	1.27 mm	○(7.62 mm)	○(7.62 mm)	—
	24-pin	1.27 mm	○(7.62 mm)	○(7.62 mm)	○(9.53 mm)
	28-pin	1.27 mm	—	○(9.53 mm)	○(9.53 mm)
Shrink SOP	24-pin	0.65 mm	—	○(7.62 mm)	—
	30-pin	0.65 mm	—	○(7.62 mm)	—
	36-pin	0.80 mm	○(7.62 mm)	○(7.62 mm)	—
	38-pin	0.65 mm	—	○(7.62 mm)	—
QFP	48-pin	0.5 mm	○ (7 x 7)	○ (7 x 7)	○ (7 x 7)
	56-pin	0.65 mm	—	○ (10 x 10)	○ (10 x 10)
	80-pin	0.65 mm	—	—	○ (14 x 14)
TQFP	48-pin	0.5 mm	—	○ (7 x 7)	○ (7 x 7)

- Remarks**1. In the above table, '○' indicates a package that is available, and '—' indicates a package that is unavailable.
2. Some packages may have unavailable pins. Please refer to the **Analog Master Package Manual (A10495E)** for unavailable pins.

Package availability of M-CHS family

Package		Lead Pitch	μPC5200	μPC5201	μPC5202	μPC5203	μPC5204
DIP	8-pin	2.54 mm	—	—	—	—	—
	14-pin	2.54 mm	—	—	—	—	—
	16-pin	2.54 mm	—	—	—	—	—
	18-pin	2.54 mm	—	—	—	—	—
	22-pin	2.54 mm	—	—	—	—	—
	24-pin	2.54 mm	—	—	—	—	—
	28-pin	2.54 mm	—	—	—	—	—
	42-pin	2.54 mm	—	—	—	—	—
Shrink DIP	14-pin	1.778 mm	—	—	—	—	—
	20-pin	1.778 mm	—	—	—	—	—
	24-pin	1.778 mm	○	○	—	—	—
	28-pin	1.778 mm	—	—	○	—	—
	30-pin	1.778 mm	—	—	—	—	—
	42-pin ^{Note}	1.778 mm	—	—	○	—	—
	48-pin ^{Note}	1.778 mm	—	—	—	○	—
SOP	16-pin	1.27 mm	○ (7.62 mm)	—	—	—	—
	20-pin	1.27 mm	○ (7.62 mm)	—	—	—	—
	24-pin	1.27 mm	○ (7.62 mm)	○ (7.62 mm)	○ (9.53 mm)	—	—
	28-pin	1.27 mm	—	○ (9.53 mm)	○ (9.53 mm)	—	—
Shrink SOP	20-pin	0.65 mm	○ (7.62 mm)	○ (7.62 mm)	—	—	—
	24-pin	0.65 mm	—	○ (7.62 mm)	—	—	—
QFP	48-pin	0.5 mm	—	○ (7 x 7)	—	—	—
		0.65 mm	—	—	○ (10 x 10)	—	—
		0.8 mm	○ (10 x 14)	—	—	○ (10 x 14)	—
	56-pin	0.65 mm	—	—	—	—	○ (10 x 10)
	64-pin	1.0 mm	—	—	—	○ (14 x 20)	—
	72-pin	0.5 mm	—	—	—	—	○ (10 x 10)
	80-pin	0.65 mm	—	—	—	—	○ (14 x 14)
TQFP	48-pin	0.5 mm	—	○ (7 x 7)	—	—	—

Note Because the time is required to prepare for production, consult NEC before development. Also consult NEC when you use 42-pin, or 48-pin shrink DIP packages.

Remarks1. In the above table, '○' indicates a package that is available, and '—' indicates a package that is unavailable.

2. Some packages may have unavailable pins. Please refer to the **Analog Master Package Manual (A10495E)** for unavailable pins.

Development of Analog Master

The development of the Analog Master is completed by both the user and NEC. Passing the development work from the user to NEC is called interfacing.

NEC supports only the circuit diagram level interface.

Interface Level	System Design	Circuit Design	Layout Design	ES Production
Circuit design level	User's works		NEC's works	

● Circuit diagram level interface

User completes up to system design, NEC takes over all subsequent works, such as circuit design and simulation.

This interface level is classified into 3 more levels as shown in the table below, depending on parts configuring the circuit and whether or not to create and estimate a breadboard.

Level	Creation and Estimation of Breadboard	Parts Configuring the Circuit
S level	Not necessary	General-purpose SSI ^{Note 1} , Standard SSI ^{Note 2} , Transistor for small signal, Analog Master TEG ^{Note 3} , Resistors, Capacitors
A level	Necessary	Standard SSI ^{Note 2} , Transistor for small signal, Analog Master TEG ^{Note 3} , Resistors, Capacitors
B level	Necessary	Analog Master TEG ^{Note 3} , Resistors, Capacitors (80 % or more is configured with macro)

Notes 1. General-purpose SSI : SSI except standard SSI

2. Standard SSI : OP amp. (μ PC151/741, 251/1458, 258/4558, 451/324, 458/4741, 802/4250, 842, 844, 1251/358, 4556, and equivalents of other manufacturers)

: Comparator (μ PC177/1339, 271/311, 272/319, 277/393, and equivalents of other manufacturers)

: Regulator (Three-terminal regulator, Shunt regulator)

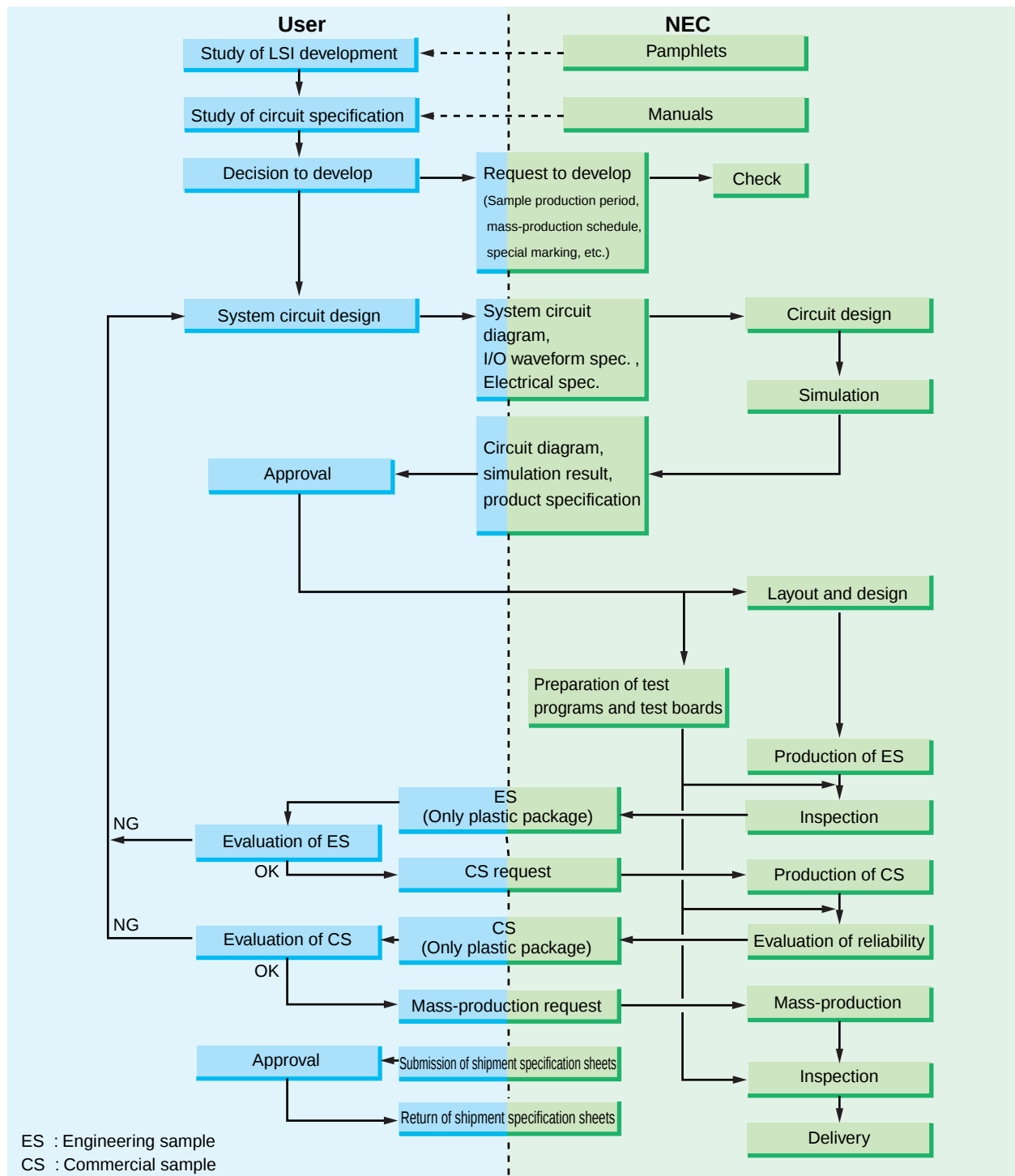
: Function block (μ PC617/1555, and equivalents of other manufacturers)

3. Analog Master TEG : Library TEGs, basic block TEGs, super white TEGs provided by NEC.

Remark TEG (Test Element Group) is a sample for evaluation.

Development of Analog Master

Flow for circuit diagram level interface



Remark Unlike CS and mass-produced model, the quality of ES is not guaranteed.
Therefore, do not use the ES for production or reliability testing.

Works by user

(1) Study of circuit specifications

User checks circuit requirements such as supply voltage range, pin voltages, circuit performance, package, and resistance to electro-static discharge (ESD) damage, according to manuals supplied by NEC.

(2) Request to develop

User requests NEC to develop the chip, and provides detailed descriptions of the followings.

1. Interface level
2. Master name, package
3. Scheduled interface date, ES/CS delivery date, schedule of mass-production
4. Request of special marking
5. Request of TEG

(3) Circuit design

User designs circuit configuration so as to realize required function and performance using parts configuring circuit on page 22 (system circuit design).

(4) Interface (circuit diagram level interface)

User sends the following interface documents to NEC after completion of system circuit design.

1. System block diagram
2. System circuit diagram
3. I/O waveform specifications
4. Electrical specifications
5. Check sheet

It is recommended that the above documentation be submitted on special forms supplied by NEC.

Describe in as much detail as possible because this is important information for IC design and simulation.

(5) Approval of circuit diagram

Circuit diagram designed by NEC, simulation result, and product specification are sent to user.

After all items are checked and approved by user, NEC starts layout design and ES production.

(6) Evaluation of ES and request to prepare CS

User evaluates engineering samples (ES). Two levels of samples are sent. One is standard sample, and the other called variation sample is for assertion of electrical characteristics (note that NEC does not assure characteristic variation to user with this sample). After the samples pass evaluation, user requests NEC to prepare commercial samples (CS) after discussing and determining actual specification of test condition list.

(7) Evaluation of CS and request to start mass-production

User evaluates commercial samples (CS).

After the samples pass evaluation, user requests NEC to start mass production.

Works by NEC

(1) Helping user in studying LSI development

When user plans to develop particular LSIs, NEC is ready to give advices on whether the user's circuit specifications can be achieved from the viewpoint of the number of elements and element characteristics. Please consult NEC after determining the specifications.

(2) Circuit design

According to user's circuit requirements, NEC completes circuit design, and simulation, and prepares test conditions. This testing is only for DC items.

(3) Layout design

Layout design requires 1 to 4 weeks. In addition, before completion of layout design, back annotation is performed.

Characteristics will be checked by extracting the parasitic elements to feedback to the circuit design side and performing simulation. Layout design requires one additional week for this checking.

(4) ES production

The user will usually receive the ES 3 to 4 weeks after completion of layout design.

(5) CS production

After request by user, NEC starts production of commercial samples.

From CS production request, it takes in general 1 month for standard quality grade device, and 2.5 month for special quality grade device to deliver the CS.

The above schedule is conditional upon whether the product specifications have been determined between the user and NEC.

(6) Preparation of shipment specification sheets

The shipment specification sheets describe absolute maximum ratings, electrical characteristics, package outline, and marking.

(7) Mass-production

NEC mass-produces the LSI according to the user's production schedule.

The export of this product from Japan is regulated by the Japanese government. To export this product may be prohibited without governmental license, the need for which must be judged by the customer. The export or re-export of this product from a country other than Japan may also be prohibited without a license from that country. Please call an NEC sales representative.

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(1) "NEC" as used in this statement means NEC Corporation and also includes its majority-owned subsidiaries.

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